ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Material Composition Declaration This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions. This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. Adobe Reader version 7.0.5 is required to complete this declaration.									
IPC-1752-1 v1.02	IPC Web Site for Information on I http://www.ipc.org/IPC-175x	PC-1752 Standard	Form Type	Form Type * Declaration Class *						
Supplier Information										
Company Name *	Company Unique ID	Unique ID Authority	Response Da	Response Date *		Response Document ID				
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *							
Authorized Representati	ve * Title - Representative	Phone - Representative *	Email - Repre	mail - Representative *		Supplier Comments or URL for Additional Information				
Requester Item Numbe	r Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufa	acturing Site	Weight	UOM	Unit Type	
Alternate Recommendation	ation			Alternate	Item Co	omments				

Manufacturing Information section intentionally omitted.

Save the fields i this form to a file		Clear all of the fields on this form	Lock the fields on this form to prevent changes				
RoHS Materia	Composition Declaration		Declaration Type *				
	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogene Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mas						
RoHS Declaratio	n *		Supplier Acceptance				
Exemptions: If the	declared item does not contain RoHS restricted substances per the definition ab xes will appear below. Check all applicable exemptions.	ove except for defined RoHS e					
1. Mercury in comp	act fluorescent lamps not exceeding 5 mg per lamp.	7c. Lead in electronic ceramic	parts (e.g. piezoelectronic devices).				
2a. Mercury in stra halophosphate lan	ght fluorescent lamps for general purposes not exceeding 10 mg. in ps	 Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations piezoelectronic devices). 					
2b. Mercury in stra lamps with a norm	ght fluorescent lamps for general purposes not exceeding 5 mg. in triphosphate Il lifetime	 Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators 					
2c. Mercury in stra lamps with long life	ght fluorescent lamps for general purposes not exceeding 8 mg. in triphosphate time	10a. Deca BDE in polymeric applications					
3. Mercury in straig	ht fluorescent lamps for special purposes.	10b. Lead in lead/bronze bearing shells and bushes					
4. Mercury in other	lamps not specifically mentioned in this list.	11. Lead used in compliant pin connector systems.					
5. Lead in glass of	cathode ray tubes, electronic components and fluorescent tubes.	12. Lead as a coating material for a thermal conduction module c-ring.					
6a. Lead as an allo	ying element in steel containing up to 0.35% lead by weight.	13a. Lead in optical and filter glass.					
6b. Lead as an allo	ying element in aluminum containing up to 0.4% lead by weight.	13b. Cadmium in optical and filter glass.					
6c. Lead as an allo	ying element in copper containing up to 4% lead by weight.	14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight .					
7a. Lead in high m weight or more lea	elting temperature type solders (i.e. lead based solder alloys containing 85% by d).	15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.					
	for servers, storage and storage array systems, network infrastructure equipment lling, transmission as well as network management for telecommunications.						
Declaration S	ignature						
	omplete all of the required fields on all pages of this form. Select the "Acc	cepted" on the Supplier Acce	eptance drop-down. This will display the signature area. Digitally sign				
	required by the Requester) and click on Submit Form to have the form retu						
Supplier Digital S	ignature						

Joint Industry Guide (JIG) Material Composition Declaration for Electronic Products

Instructions: Declare whether the item substances exceed the threshold levels shown in the table and report accordingly. Where threshold levels include the words "intentionally added", substances must be declared if they are added intentionally, regardless of threshold level. For each RoHS substance, identified with dual asterisks (**), report the worst case PPM at the homogeneous material level and optionally the total weight of the substance in the item. For all remaining (non-RoHS) JIG A & B substances, and any additional substances, report the total weight and optionally the PPM at the part level for each item.

JIG	Category Name	Threshold Level	Above Threshold Level?	If yes, enter total weight and worse case PPM		veight and PPM	Description of Use
Level	As defined in the Joint Industry Guide	Intentionally added or PPM	Yes/No	Weight UoM PPM		PPM	

OTHER Material Composition Declaration

Requester Instructions: The requester can optionally include additional substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances. The requester should enter additional substances as well as the threshold levels that specify the substance at the item level.

Supplier Instructions: Explicitly declare whether the item exceed the threshold level by selecting Yes or No. If the maximum concentration of any substance exceeds the threshold levels defined by the requester, then the substance content must be reported in total weight and/or worst case PPM, along with a description of material use.

JIG	Category Name	Threshold Level
Other	As defined by the Requester	Defined by the Requester